







**INA241A, INA241B** 

SBOSA30B - MARCH 2022 - REVISED JULY 2023

# INA241x -5 V to 110 V, Bidirectional, Ultra-Precise Current Sense Amplifier With **Enhanced PWM Rejection**

#### 1 Features

- Enhanced PWM rejection optimized for systems subject to switching common-mode voltages
  - Supports switching frequencies up to 125 kHz
- Wide common-mode voltage:
  - Operational voltage: -5 V to +110 V
  - Survival voltage: -20 V to +120 V
- Bidirectional operation
- High small signal bandwidth: 1.1 MHz (at all gains)
- Slew rate: 8 V/µs
- Step response settling time to 1%: 1 µs
- **Excellent CMRR** 
  - 166 dB DC-CMRR
  - 104 dB AC-CMRR at 100 kHz
  - 89 dB AC-CMRR at 1 MHz
- Accuracy:
  - Gain error (maximum)
    - Version A: ±0.01%, ±1 ppm/°C drift
    - Version B: ±0.1%, ±5 ppm/°C drift
  - Offset voltage (maximum)
    - Version A: ±10 μV, ±0.1 μV/°C drift
    - Version B: ±150 μV, ±0.5 μV/°C drift
- Available gains:
  - INA241A1, INA241B1 : 10 V/V
  - INA241A2, INA241B2 : 20 V/V
  - INA241A3, INA241B3 : 50 V/V
  - INA241A4, INA241B4 : 100 V/V
  - INA241A5, INA241B5 : 200 V/V
- Package options: SOT23-8, VSSOP-8, SOIC-8, VSSOP-10

# 2 Applications

- Motor drives
- Solenoids and actuators
- Injection molding machine
- Cordless power tools
- Medical cordless tools
- Drone propeller speed control

## 3 Description

The INA241x is an ultra-precise, bidirectional current sense amplifier than can measure voltage drops across shunt resistors over a wide common-mode range from -5 V to 110 V, independent of the supply voltage. The high-precision current measurement is achieved through a combination of low offset voltage (±10 µV, maximum), small gain error (±0.01%, maximum) and a high DC CMRR (typical 166 dB). The INA241x is designed for high voltage, bidirectional measurements in switching systems that see large common-mode voltage transients at the device's inputs. The enhanced PWM rejection circuitry inside the INA241x ensures minimal signal disturbance at the output due to the common-mode voltage transitions at the input.

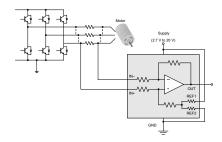
The INA241x operates from a single 2.7 V to 20 V supply, drawing 2.5 mA of supply current. The INA241x is available in five gain options: 10 V/V, 20 V/V, 50 V/V, 100 V/V, and 200 V/V. Multiple gain options allow for optimization between available shunt resistor values and wide output dynamic range requirements.

The INA241x is specified over operating temperature range of -40°C to +125°C.

### Package Information

PART NUMBER	PACKAGE <sup>(1)</sup>	PACKAGE SIZE <sup>(2)</sup>		
INA241A INA241B	SOT-23 (8)	2.90 mm × 2.80 mm		
	VSSOP (8)	3.00 mm × 4.90 mm		
	SOIC (8) <sup>(3)</sup>	4.90 mm × 5.95 mm		
	VSSOP (10) <sup>(3)</sup>	3.00 mm × 4.90 mm		

- For all available packages, see the package option addendum at the end of the data sheet.
- The package size (length × width) is a nominal value and includes pins, where applicable.
- Package is preview only



**Typical Application - Inline Motor Control** 



# **Table of Contents**

1 Features	1	8.3 Feature Description	16
2 Applications	1	8.4 Device Functional Modes	18
3 Description		9 Application and Implementation	23
4 Revision History		9.1 Application Information	23
5 Device Comparison	3	9.2 Typical Application	
6 Pin Configuration and Functions	3	9.3 Power Supply Recommendations	
7 Specifications	<mark>5</mark>	9.4 Layout	26
7.1 Absolute Maximum Ratings		10 Device and Documentation Support	
7.2 ESD Ratings		10.1 Receiving Notification of Documentation Update	es <mark>28</mark>
7.3 Recommended Operating Conditions	<mark>5</mark>	10.2 Support Resources	28
7.4 Thermal Information		10.3 Trademarks	
7.5 Electrical Characteristics	6	10.4 Electrostatic Discharge Caution	28
7.6 Typical Characteristics		10.5 Glossary	
8 Detailed Description		11 Mechanical, Packaging, and Orderable	
8.1 Overview	16	Information	28
8.2 Functional Block Diagram			

# **4 Revision History**

Cł	nanges from Revision A (August 2022) to Revision B (July 2023)	Page
•	Added the D and DGS packages to the data sheet	1
•	Changed package information from body size to package size	1
•	Removed preview note from DGK package from package information table	1
•	Added the D and DGS packages pin configuration	3
•	Added DGS package in recommended layout examples	26
Cr	nanges from Revision * (March 2022) to Revision A (August 2022)	Page
•	Changed data sheet status from Advanced Information to Production Data	1

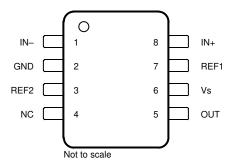


# **5 Device Comparison**

**Table 5-1. Device Comparison** 

DEVICE NAME	GAIN
INA241A1, INA241B1	10 V/V
INA241A2, INA241B2	20 V/V
INA241A3, INA241B3	50 V/V
INA241A4, INA241B4	100 V/V
INA241A5, INA241B5	200 V/V

# **6 Pin Configuration and Functions**



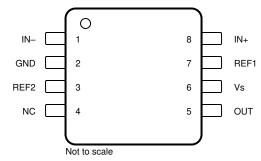


Figure 6-1. INA241x: DDF Package 8-Pin SOT-23 Top View

Figure 6-2. INA241x: D and DGK Package 8-Pin SOIC and 8-Pin VSSOP Top View

Table 6-1. Pin Functions: D, DDF and DGK Packages

I	PIN	TYPE	DESCRIPTION
NAME	NO.	ITPE	DESCRIPTION
GND	2	Ground	Ground
IN+	8	Input	Current-sense amplifier positive input. For high-side applications, connect to bus-voltage side of sense resistor. For low-side applications, connect to load side of sense resistor.
IN-	1	Input	Current-sense amplifier negative input. For high-side applications, connect to load side of sense resistor. For low-side applications, connect to ground side of sense resistor.
NC	4	Ground	Reserved. Connect to ground.
OUT	5	Output	Output voltage
REF1	7	Input	Reference 1 voltage. Connect to voltage potential from 0 V to V <sub>S</sub> ; see <i>Adjusting the Output With the Reference Pins</i> for connection options.
REF2	3	Input	Reference 2 voltage. Connect to voltage potential from 0 V to V <sub>S</sub> ; see <i>Adjusting the Output With the Reference Pins</i> for connection options.
Vs	6	Power	Power supply, 2.7 V to 20 V



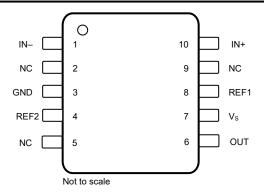


Figure 6-3. INA241x: DGS Package 10-Pin VSSOP Top View

1. DGS (VSSOP) package is preview only.

Table 6-2. Pin Functions: DGS Package

	Table 6-2. Fill Fullctions. DGS Fackage					
	PIN	TYPE	DESCRIPTION			
NAME	NO.	ITPE	DESCRIPTION			
GND	3	Ground	Ground			
IN+	10	Input	Current-sense amplifier positive input. For high-side applications, connect to bus-voltage side of sense resistor. For low-side applications, connect to load side of sense resistor.			
IN-	1	Input	Current-sense amplifier negative input. For high-side applications, connect to load side of sense resistor. For low-side applications, connect to ground side of sense resistor.			
NC	5	Ground	erved. Connect to ground.			
NC	2	_	Leave unconnected			
NC	9	_	Leave unconnected			
OUT	6	Output	Output voltage			
REF1	8	Input	Reference 1 voltage. Connect to voltage potential from 0 V to V <sub>S</sub> ; see <i>Adjusting the Output With the Reference Pins</i> for connection options.			
REF2	4	Input	Reference 2 voltage. Connect to voltage potential from 0 V to V <sub>S</sub> ; see <i>Adjusting the Output With the Reference Pins</i> for connection options.			
V <sub>S</sub>	7	Power	Power supply, 2.7 V to 20 V			

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
Supply voltage (V <sub>S</sub> )			22	V
Analog inputs, V <sub>IN+</sub> , V <sub>IN-</sub> <sup>(2)</sup>	Differential (V <sub>IN+</sub> ) - (V <sub>IN-</sub> )	-30	30	V
	Common-mode	-20	120	V
REF1, REF2, NC inputs		GND - 0.3	V <sub>S</sub> + 0.3	٧
Output		GND - 0.3	Vs + 0.3	V
T <sub>A</sub>	Operating temperature	-55	150	°C
T <sub>J</sub>	Junction temperature		150	°C
T <sub>stg</sub>	Storage temperature	-65	150	°C

<sup>(1)</sup> Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

## 7.2 ESD Ratings

			VALUE	UNIT
V	Floatroatatic disabarra	Human body model (HBM), per ANSI/ESDA/ JEDEC JS-001, all pins <sup>(1)</sup>	±2000	V
V <sub>(ESD)</sub>	Electrostatic discharge	Charged device model (CDM), per ANSI/ESDA/ JEDEC JS-002, all pins <sup>(2)</sup>	±1000	V

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V <sub>CM</sub>	Common-mode input range	-5	48	110	V
Vs	Operating supply range	2.7	5	20	V
T <sub>A</sub>	Ambient temperature	-40		125	°C

### 7.4 Thermal Information

THERMAL METRIC(1)		INA241x				
		DDF (SOT23)	DGK (VSSOP)	D (SOIC) <sup>(2)</sup>	DGS (VSSOP)(2)	UNIT
		8 PINS	8 PINS	8 PINS	10 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	129.7	167.2	TBD	TBD	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	58	58.9	TBD	TBD	°C/W
R <sub>θJB</sub>	Junction-to-board thermal resistance	52.6	88.9	TBD	TBD	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	2.3	8.1	TBD	TBD	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	52.3	87.4	TBD	TBD	°C/W

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

<sup>(2)</sup>  $V_{IN+}$  and  $V_{IN-}$  are the voltages at the IN+ and IN- pins, respectively.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

This package is preview only.



## 7.5 Electrical Characteristics

at  $T_A$  = 25 °C,  $V_S$  = 5 V,  $V_{SENSE}$  =  $V_{IN+}$  -  $V_{IN-}$ ,  $V_{CM}$  =  $V_{IN-}$  = 48 V, and  $V_{REF1}$  =  $V_{REF2}$  =  $V_S$  / 2 (unless otherwise noted)

at 1 <sub>A</sub> 2	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
INPUT							
V <sub>CM</sub>	Common-mode input range <sup>(1)</sup>	$V_{IN+}$ , $V_{IN-} = -5 \text{ V to } 110 \text{ V}$ , $V_{SENSE} = 0 \text{ mV}$ $T_A = -40^{\circ}\text{C}$ to $125^{\circ}\text{C}$	<b>–</b> 5		110	V	
		$V_{IN+}$ , $V_{IN-} = -5$ V to 110 V, $V_{SENSE} = 0$ mV $T_A = -40$ °C to 125°C, INA241A	150	166		dB	
CMRR	Common-mode rejection ratio, input- referred	$V_{IN+}$ , $V_{IN-}$ = -5 V to 110 V, $V_{SENSE}$ = 0 mV $T_A$ = -40°C to 125°C, INA241B	120	130			
		f = 50 kHz		105			
		V <sub>SENSE</sub> = 0 mV, INA241A1		±5	±20		
		V <sub>SENSE</sub> = 0 mV, INA241A2		±3	±15		
$V_{os}$	Offset voltage, input-referred	V <sub>SENSE</sub> = 0 mV, INA241A3, INA241A4		±3	±10	μV	
ı		V <sub>SENSE</sub> = 0 mV, INA241A5		±2	±8		
		V <sub>SENSE</sub> = 0 mV, INA241B		±25	±150		
		T <sub>A</sub> = -40°C to 125°C, INA241A1		±50	±250		
	Offset voltage drift, input-referred	$T_A = -40^{\circ}\text{C to } 125^{\circ}\text{C}, INA241A2$		±30	±150		
dV <sub>os</sub> /dT		T <sub>A</sub> = -40°C to 125°C, INA241A3, INA241A4, INA241A5		±20	±100	nV/°C	
		T <sub>A</sub> = -40°C to 125°C, INA241B		±100	±500		
	Power-supply rejection ratio, input- referred	$V_S = 2.7 \text{ V to } 20 \text{ V, } V_{SENSE} = 0 \text{ mV,}$ $V_{REF1} = V_{REF2} = 1 \text{ V,}$ $V_A = -40 ^{\circ}\text{C to } 125 ^{\circ}\text{C, INA241A1}$		±0.2	±1		
		$V_S = 2.7 \text{ V to } 20 \text{ V, } V_{SENSE} = 0 \text{ mV,}$ $V_{REF1} = V_{REF2} = 1 \text{ V,}$ $T_A = -40 ^{\circ}\text{C to } 125 ^{\circ}\text{C, INA241A2}$		±0.1	±0.75		
PSRR		$V_S$ = 2.7 V to 20 V, $V_{SENSE}$ = 0 mV, $V_{REF1}$ = $V_{REF2}$ = 1V, $T_A$ = $-40^{\circ}$ C to 125°C, INA241A3, INA241A4, INA241A5		±0.06	±0.5		
		$V_S = 2.7 \text{ V to } 20 \text{ V, } V_{SENSE} = 0 \text{ mV,}$ $V_{REF1} = V_{REF2} = 1 \text{ V,}$ $T_A = -40 ^{\circ}\text{C to } 125 ^{\circ}\text{C, INA241B}$		±1	±10		
I <sub>B</sub>	Input bias current	I <sub>B+</sub> , I <sub>B-</sub> , V <sub>SENSE</sub> =0 mV	25	35	45	uA	
	Reference input range		0		Vs	V	
OUTPUT	T						
		A1, B1 Devices		10		V/V	
		A2, B2 Devices		20		V/V	
G	Gain	A3, B3 Devices		50		V/V	
		A4, B4 Devices		100		V/V	
		A5, B5 Devices		200		V/V	

Submit Document Feedback



at  $T_A = 25$  °C,  $V_S = 5$  V,  $V_{SENSE} = V_{IN+} - V_{IN-}$ ,  $V_{CM} = V_{IN-} = 48$  V, and  $V_{REF1} = V_{REF2} = V_S$  / 2 (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT	
		(GND + 50 mV) < V <sub>OUT</sub> < (V <sub>S</sub> - 200 mV), INA241A1, INA241A2, INA241A3	±0.002	±0.01		
	Gain Error	(GND + 50 mV) < V <sub>OUT</sub> < (V <sub>S</sub> - 200 mV), INA241A4, INA241A5	±0.003	±0.015	%	
G		(GND + 50 mV) < V <sub>OUT</sub> < (V <sub>S</sub> - 200 mV), INA241B	±0.02	±0.1		
G <sub>ERR</sub>		T <sub>A</sub> = -40°C to +125°C, INA241A1, INA241A2, INA241A3	±0.05	±1	ppm/°C	
	Gain Error Drift	T <sub>A</sub> = -40°C to +125°C, INA241A4, INA241A5	±0.1	±2		
		T <sub>A</sub> = -40°C to +125°C, INA241B	±0.2	±5		
	Non-Linearity Error		±0.001		%	
	Maximum Capacitive Load	No sustained oscillations, No isolation resistor	1		nF	
VOLTAC	GE OUTPUT					
	Swing to V <sub>S</sub> Power Supply Rail	$R_L = 10 \text{ k}\Omega \text{ to GND},$ $T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	V <sub>S</sub> - 0.07	V <sub>S</sub> - 0.2	V	
	Swing to Ground	$R_L = 10 \text{ k}\Omega \text{ to GND, } V_{SENSE} = 0$ $mV$ , $V_{REF1} = V_{REF2} = 0 \text{ V}$ , $T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	8	20	mV	
REFERE	ENCE INPUT					
		V <sub>REF1</sub> = V <sub>REF2</sub> = 0.5 V to 4.5 V, T <sub>A</sub> = -40°C to +125°C, INA241A1	±1	±2.5		
RVRR	Reference voltage rejection ratio, input- referred	V <sub>REF1</sub> = V <sub>REF2</sub> = 0.5 V to 4.5 V, T <sub>A</sub> = -40°C to +125°C, INA241A2, INA241A3, INA241A4, INA241A5	±0.5	±1.5	μV/V	
		V <sub>REF1</sub> = V <sub>REF2</sub> = 0.5 V to 4.5 V, T <sub>A</sub> = -40°C to +125°C, INA241B,	±10	±20		
		$\begin{aligned} &V_{OUT} = \left  \left( V_{REF1} + V_{REF2} \right) \right  / 2 \text{ at } V_{SENSE} = 0 \\ &mV, \\ &V_{REF1} = V_S,  V_{REF2} = GND \\ &V_{REF1} = GND,  V_{REF2} = V_S \\ &T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C, INA241A1,} \\ &INA241A2 \end{aligned}$	±0.002	±0.005		
	Reference divider accuracy	$\begin{split} V_{OUT} &= \left  \left( V_{REF1} + V_{REF2} \right) \right  / 2 \text{ at } V_{SENSE} = 0 \\ \text{mV}, \\ V_{REF1} &= V_S, V_{REF2} = \text{GND} \\ V_{REF1} &= \text{GND}, V_{REF2} = V_S \\ T_A &= -40^{\circ}\text{C to } +125^{\circ}\text{C, INA241A3,} \\ \text{INA241A4, INA241A5} \end{split}$	±0.002	±0.01	%	
		$V_{OUT} =  (V_{REF1} + V_{REF2})  / 2 \text{ at } V_{SENSE} = 0$ mV, $V_{REF1} = V_S$ , $V_{REF2} = GND$ $V_{REF1} = GND$ , $V_{REF2} = V_S$ $V_{A} = -40^{\circ}C$ to +125°C, , INA241B	±0.02	±0.15		
FREQU	ENCY RESPONSE					
BW	Bandwidth	All Gains, −3dB Bandwidth	1.1		MHz	
		$V_{\text{IN+}}$ , $V_{\text{IN-}}$ = 48 V, $V_{\text{OUT}}$ = 0.5 V to 4.5 V, Output settles to 0.5%	1.5		μs	
	Settling time	$V_{\text{IN+}}$ , $V_{\text{IN-}}$ = 48 V, $V_{\text{OUT}}$ = 0.5 V to 4.5 V, Output settles to 1%	1		μs	
		$V_{\text{IN+}}$ , $V_{\text{IN-}}$ = 48 V, $V_{\text{OUT}}$ = 0.5 V to 4.5 V, Output settles to 5%	0.5		μs	
SR	Slew Rate	Rising	8		V/µs	



at  $T_A = 25$  °C,  $V_S = 5$  V,  $V_{SENSE} = V_{IN+} - V_{IN-}$ ,  $V_{CM} = V_{IN-} = 48$  V, and  $V_{REF1} = V_{REF2} = V_S$  / 2 (unless otherwise noted)

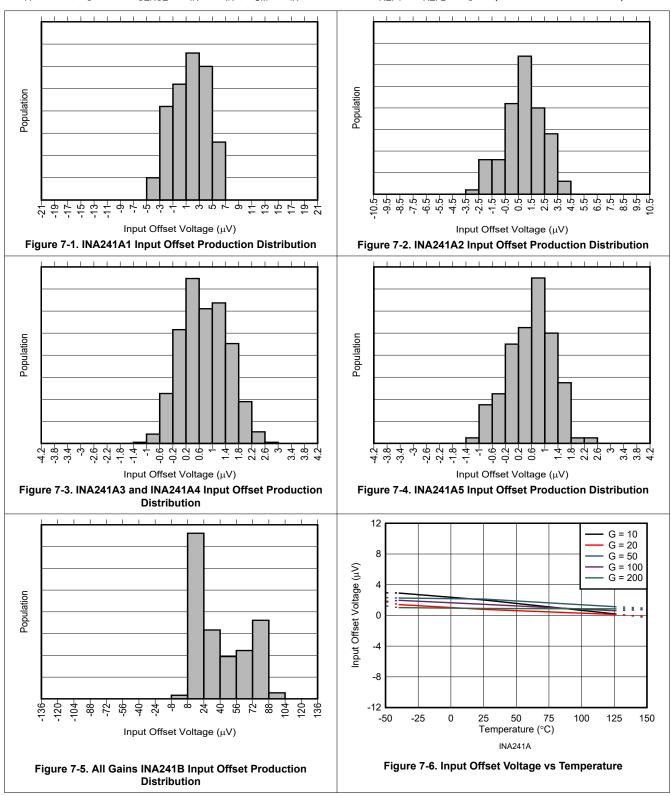
~. · A	- A = 0, 13 0 1, 15ENSE 1 NT 1 N= 10 1, 41.14 1 REF1 1 REF2 13, = (41.1100 11.							
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
NOISE	(Input reffered)	·						
	Voltage noise density A	A1, B1 Devices		62				
		A2, B2 Devices		49				
		A3, B3 Devices		39				
		A4, B4 Devices		36				
		A5, B5 Devices		28				
POWE	R SUPPLY	·	•		'			
Vs	Supply Voltage		2.7		20	V		
		V <sub>SENSE</sub> = 0 mV		2.5	3	mA		
IQ	Quiescent current	$V_{SENSE} = 0$ mV, $T_A = -40$ °C to+125°C			3.2	mA		
TEMP	ERATURE	·	•					
T <sub>A</sub>	Specified Range		-40		125	°C		

<sup>(1)</sup> Common-mode voltage at both  $V_{\text{IN-}}$  and  $V_{\text{IN-}}$  must not exceed the specified common-mode input range.



### 7.6 Typical Characteristics

at  $T_A$  = 25°C,  $V_S$  = 5 V,  $V_{SENSE}$  =  $V_{IN+}$  –  $V_{IN-}$ ,  $V_{CM}$  =  $V_{IN-}$  = 48 V, and  $V_{REF1}$  =  $V_{REF2}$  =  $V_S$  / 2 (unless otherwise noted)





at  $T_A = 25$ °C,  $V_S = 5$  V,  $V_{SENSE} = V_{IN+} - V_{IN-}$ ,  $V_{CM} = V_{IN-} = 48$  V, and  $V_{REF1} = V_{REF2} = V_S$  / 2 (unless otherwise noted)

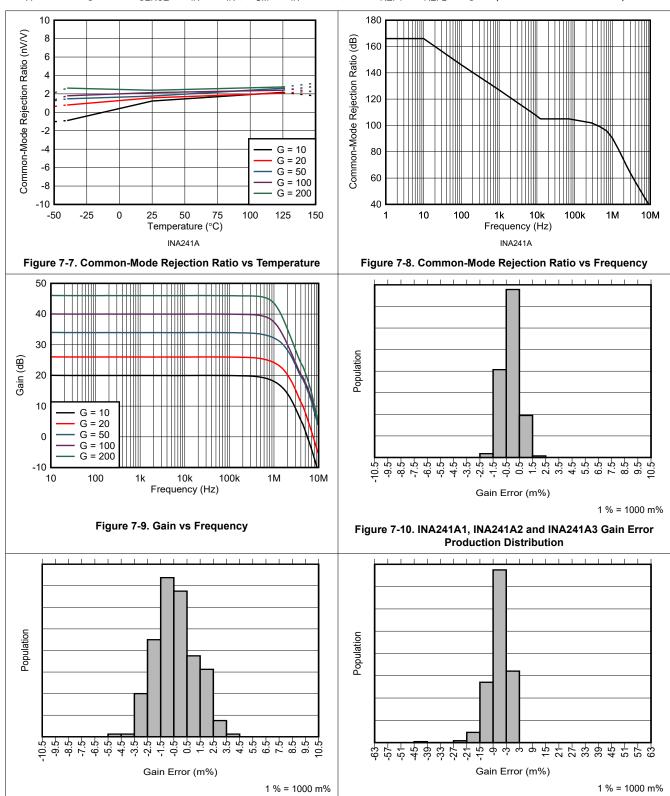


Figure 7-11. INA241A4 and INA241A5 Gain Error Production

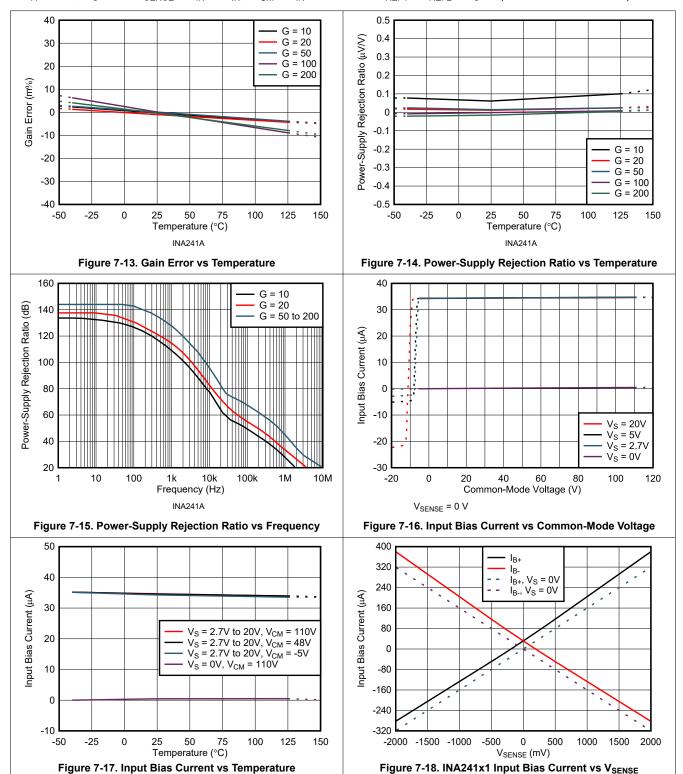
Distribution

Figure 7-12. All Gains INA241B Gain Error Production

Distribution

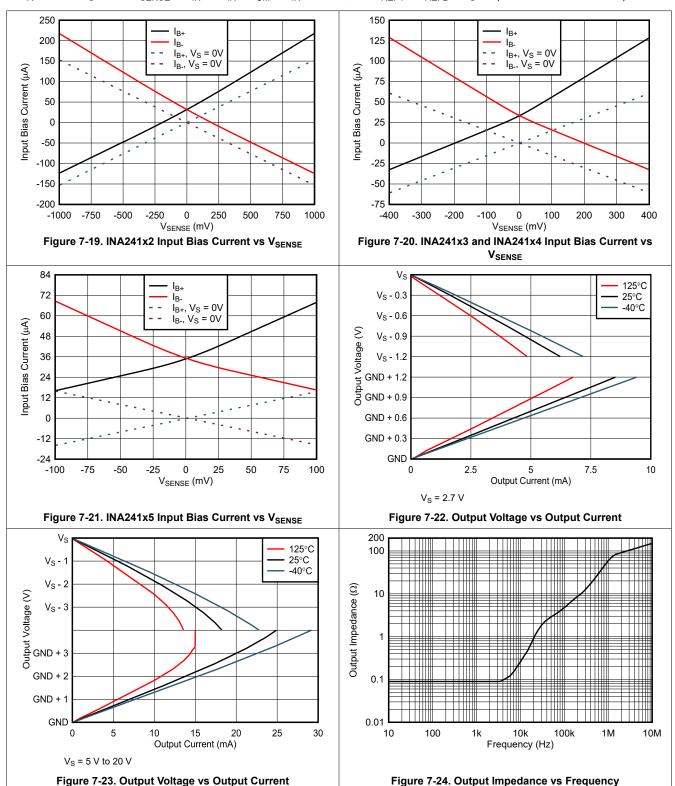


at  $T_A = 25$ °C,  $V_S = 5$  V,  $V_{SENSE} = V_{IN+} - V_{IN-}$ ,  $V_{CM} = V_{IN-} = 48$  V, and  $V_{REF1} = V_{REF2} = V_S / 2$  (unless otherwise noted)



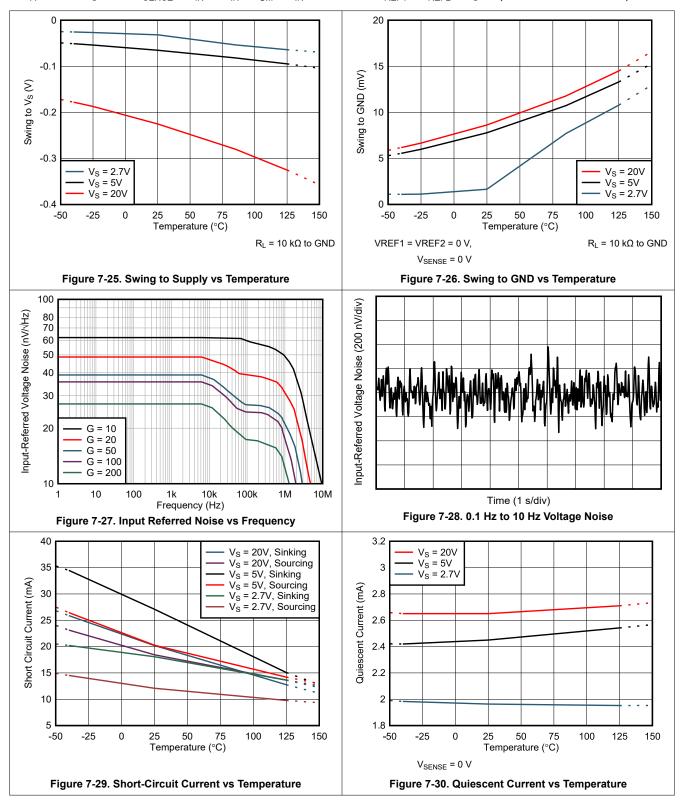


at  $T_A$  = 25°C,  $V_S$  = 5 V,  $V_{SENSE}$  =  $V_{IN+}$  –  $V_{IN-}$ ,  $V_{CM}$  =  $V_{IN-}$  = 48 V, and  $V_{REF1}$  =  $V_{REF2}$  =  $V_S$  / 2 (unless otherwise noted)



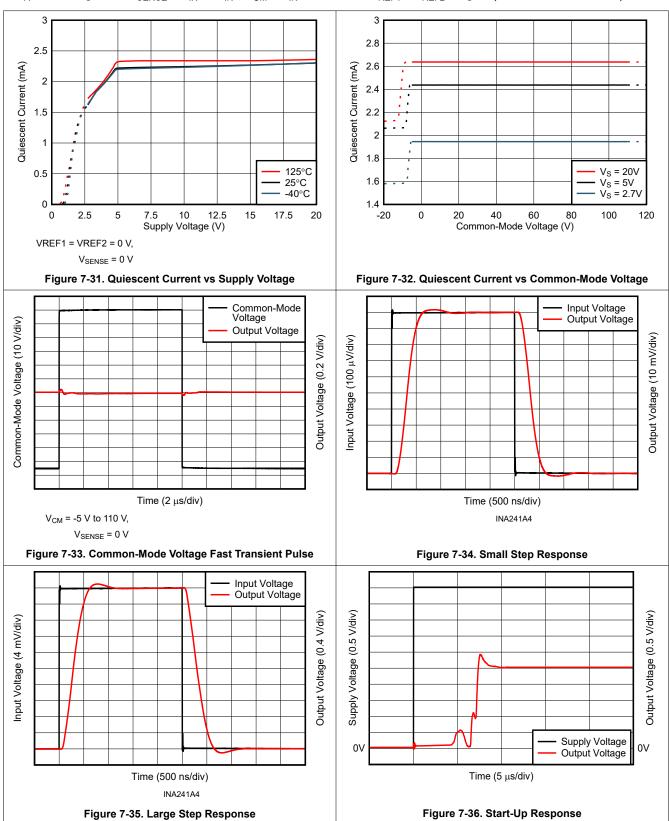


at  $T_A$  = 25°C,  $V_S$  = 5 V,  $V_{SENSE}$  =  $V_{IN+}$  –  $V_{IN-}$ ,  $V_{CM}$  =  $V_{IN-}$  = 48 V, and  $V_{REF1}$  =  $V_{REF2}$  =  $V_S$  / 2 (unless otherwise noted)



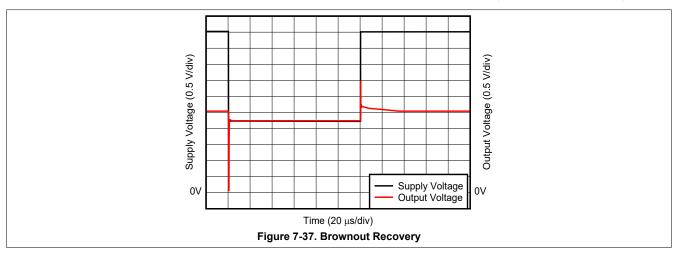


at  $T_A = 25$ °C,  $V_S = 5$  V,  $V_{SENSE} = V_{IN+} - V_{IN-}$ ,  $V_{CM} = V_{IN-} = 48$  V, and  $V_{REF1} = V_{REF2} = V_S$  / 2 (unless otherwise noted)





at  $T_A = 25^{\circ}C$ ,  $V_S = 5$  V,  $V_{SENSE} = V_{IN+} - V_{IN-}$ ,  $V_{CM} = V_{IN-} = 48$  V, and  $V_{REF1} = V_{REF2} = V_S$  / 2 (unless otherwise noted)

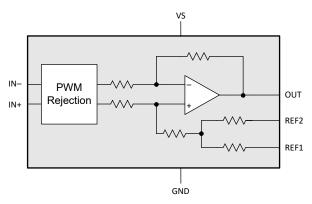


## **8 Detailed Description**

#### 8.1 Overview

The INA241x is a high-side, inline, or low-side bidirectional, high-speed current-sense amplifier that offers a wide common-mode range, precision, zero-drift topology, excellent common-mode rejection ratio (CMRR), and features enhanced pulse width modulation (PWM) rejection at the inputs of the device. Enhanced PWM rejection reduces the effect of common-mode transients that can propagate to the output signal that are associated with PWM input signals. Multiple gain versions are available to allow for the optimization of the desired full-scale output voltage based on the target current range expected in the application.

### 8.2 Functional Block Diagram



#### 8.3 Feature Description

### 8.3.1 Amplifier Input Common-Mode Signal

The INA241x supports large input common-mode voltages from -5 V to +110 V. The internal topology of the INA241x allows the common-mode range to exceed the power-supply voltage ( $V_S$ ). This allows for the INA241x to be used for low-side, inline, and high-side current-sensing applications that extend beyond the supply range of 2.7 V to 20 V.

### 8.3.1.1 Enhanced PWM Rejection Operation

The enhanced PWM rejection feature of the INA241x provides increased attenuation of large common-mode  $\Delta V/\Delta t$  transients. Large  $\Delta V/\Delta t$  common-mode transients associated with PWM signals are employed in applications such as motor or solenoid drive and switching power supplies. The disturbances that can occur at the output of a current sense amplifier from common-mode transients causes erroneous measurements and impose limitations when the output is valid. The INA241x is designed with high common-mode rejection techniques to reduce large  $\Delta V/\Delta t$  transients before the system is disturbed. As a result, this makes system design simple with INA241x. The high AC CMRR, in conjunction with signal bandwidth, allows the INA241x to minimize output disturbances and ringing during common-mode transitions when compared against traditional current-sensing amplifiers.

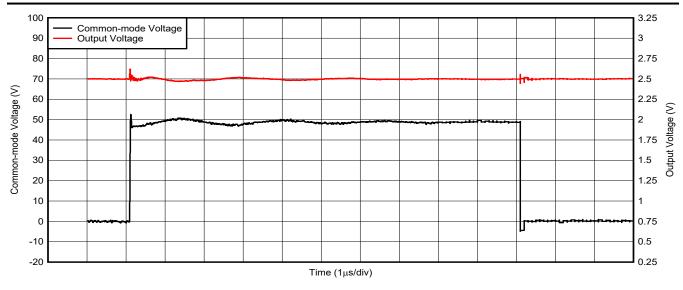


Figure 8-1. Enhanced PWM Rejection Performance

Figure 8-1 shows the INA241x PWM enhancement performance. When INA241x senses the large common-mode  $\Delta V/\Delta t$  transients, it holds the output for 1  $\mu s$ , thereby preventing the common-mode disturbance from propagating to the output. If another common-mode transient occurs during the following 3  $\mu s$ , INA241x relies on high BW and AC CMMR to attenuate the effect of common-mode transient. The enhanced PWM rejection is achieved up to a PWM frequency of 125 kHz or if common-mode transient edges are separated by a 3  $\mu s$  interval or more.

#### 8.3.1.2 Input-Signal Bandwidth

The INA241x is available with several gain options including 10 V/V, 20 V/V, 50 V/V, 100 V/V, and 200 V/V. The unique multistage design enables the amplifier to achieve high bandwidth of 1.1 MHz at all gains. This high bandwidth provides the throughput and fast response that is required for the rapid detection and processing of over-current events.

#### 8.3.1.3 Low Input Bias Current

The INA241x inputs draw 35 µA (typical) bias current per input pin at common-mode voltages as high as 110 V, which enables precision current sensing on applications that require lower current leakage. Unlike many high voltage current sense amplifiers whose input bias currents are proportional to the common-mode voltage, the input bias current of the INA241x remains constant over the entire common-mode voltage range.

### 8.3.1.4 Low V<sub>SENSE</sub> Operation

The INA241x features high performance operation across the entire valid  $V_{SENSE}$  range. The zero-drift input architecture of the INA241x provides the low offset voltage and low offset drift needed to measure low  $V_{SENSE}$  levels accurately across the wide operating temperature of  $-40^{\circ}$ C to  $+125^{\circ}$ C. Low  $V_{SENSE}$  operation is particularly beneficial when using low ohmic shunts for low current measurements, as power losses across the shunt are significantly reduced.

#### 8.3.1.5 Wide Fixed Gain Output

The INA241x maximum gain error is ±0.01% at room temperature, with a maximum drift of ±1 ppm/°C over the full temperature range of –40°C to +125°C. The INA241x is available in multiple gain options of 10 V/V, 20 V/V, 50 V/V, 100 V/V, and 200 V/V, which the system designer should select based on their desired signal-to-noise ratio and other system requirements, such as the dynamic current range and full-scale output voltage target.

#### 8.3.1.6 Wide Supply Range

The INA241x operates with a wide supply range from 2.7 V to 20 V. While the input common-mode voltage range of the INA241x is independent of the supply voltage, the output voltage is bound by the supply voltage

applied to the device. The output voltage can range from as low as 20 mV to as high as 200 mV below the supply voltage.

#### 8.4 Device Functional Modes

### 8.4.1 Adjusting the Output With the Reference Pins

Figure 8-2 shows a test circuit for reference-divider accuracy. The INA241x output is configurable to allow for unidirectional or bidirectional operation.

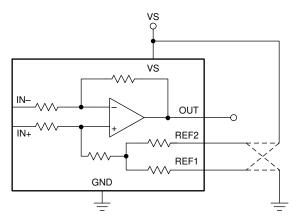


Figure 8-2. Test Circuit For Reference Divider Accuracy

The output voltage is set by applying a voltage or voltages to the reference voltage inputs, REF1 and REF2. The reference inputs are connected to an internal gain network. There is no operational difference between the two reference pins. The resistor network connected to the two reference pins are designed with ultra-precision and matching. Output is set accurately at the mid-point voltage between the voltages applied to reference voltage inputs, when current-sense input voltage is 0 V as shown in Equation 1. In most bidirectional applications, one reference input is connected to the positive supply and the other reference input is connected to the negative supply (GND pin) to set the output voltage to mid-supply.

$$V_{OUT} = G \times (V_{IN} + V_{IN}) + \frac{V_{REF1} + V_{REF2}}{2}$$
 (1)

### 8.4.2 Reference Pin Connections for Unidirectional Current Measurements

Unidirectional operation allows current measurements through a resistive shunt in one direction. For unidirectional operation, connect the device reference pins together and then to the negative rail (see the *Ground Referenced Output* section) or the positive rail (see the *VS Referenced Output* section). The required differential input polarity depends on the reference input setting. The amplifier output moves away from the referenced rail proportional to the current passing through the external shunt resistor. If the amplifier reference pins are connected to the positive rail, then the input polarity must be negative to move the amplifier output down (towards ground). If the amplifier reference pins are connected to ground, then the input polarity must be positive to move the amplifier output up (towards supply).

The following sections describe how to configure the output for unidirectional operation cases.

#### 8.4.2.1 Ground Referenced Output

When using the INA241x in a unidirectional mode with a ground referenced output, both reference inputs are connected to ground. This configuration takes the output to ground when there is a 0 V differential at the input (see Figure 8-3).

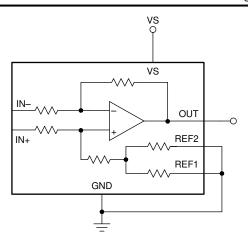


Figure 8-3. Ground Referenced Output

### 8.4.2.2 VS Referenced Output

Unidirectional mode with a VS referenced output is configured by connecting both reference pins to the positive supply. Use this configuration for circuits that require power up and stabilization of the amplifier output signal and other control circuitry before power is applied to the load (see Figure 8-4).

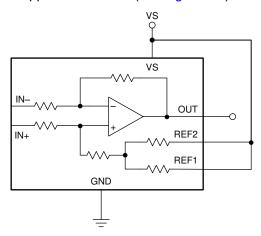


Figure 8-4. VS Referenced Output

### 8.4.3 Reference Pin Connections for Bidirectional Current Measurements

The INA241x measures the differential voltage developed by current flowing through a resistor, commonly referred to as a current-sensing resistor or a current-shunt resistor. The INA241x can operate in either a unidirectional or bidirectional mode based on the voltage potential placed on the reference pins.

The linear range of the output stage is limited to how close the output voltage can approach ground as well the supply voltage as described in the *Specifications*. The selection of the current-sensing resistor along with the current range to be measured, selection of the gain option, as well as the voltage applied to the reference pins should be chosen to keep the INA241x within the linear region of operation.

#### 8.4.3.1 Output Set to External Reference Voltage

Connecting both pins together and then to a reference voltage results in an output voltage equal to the reference voltage for the condition of shorted input pins or a 0 V differential input. Figure 8-5 shows this configuration. The output voltage decreases below the reference voltage when the IN+ pin is negative relative to the IN- pin and increases when the IN+ pin is positive relative to the IN- pin. This technique is the most accurate way to bias the output to a precise voltage.



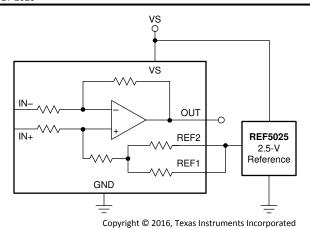


Figure 8-5. External Reference Output

### 8.4.3.2 Output Set to Mid-Supply Voltage

By connecting one reference pin to VS and the other to the GND pin, Figure 8-6 shows that the output is set at half of the supply voltage when there is no differential input. This method creates a ratiometric offset to the supply voltage, where the output voltage remains at VS / 2 for 0 V applied to the inputs.

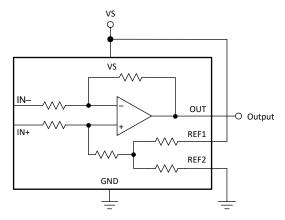


Figure 8-6. Mid-Supply Voltage Output

### 8.4.3.3 Output Set to Mid-External Reference

In this case, Figure 8-7 shows how an external reference can divided by two by connecting one REF pin to ground and the other REF pin to the reference.

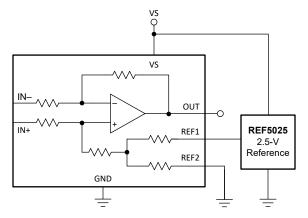


Figure 8-7. Mid-External Reference Output



### 8.4.3.4 Output Set Using Resistor Divider

The INA241x reference pins allow for the mid-point of the output voltage to be adjusted for system circuitry connections to analog to digital converters (ADCs) or other amplifiers. The reference pins are designed to be connected directly to supply, ground, or a low-impedance reference voltage. The reference pins can be connected together and biased using a resistor divider to achieve a custom output voltage. If the amplifier is used in this configuration, as shown in Figure 8-8, use the output as a differential signal with respect to the resistor divider voltage. Use of the amplifier output as a single-ended signal in this configuration is not recommended because the internal impedance shifts can adversely affect device performance specifications. If single-ended measurement is required, TI recommends to use an external op amp to buffer the resistor divider voltage (see Figure 8-9).

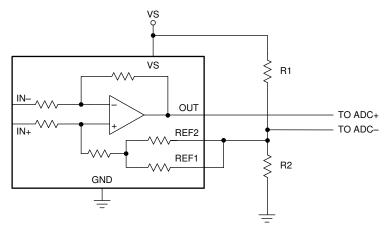


Figure 8-8. Setting the Reference Using a Resistor Divider

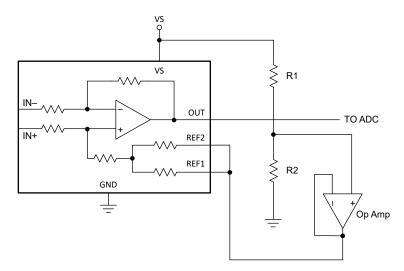


Figure 8-9. Setting the Reference Using a Resistor Divider and an Op Amp buffer



### 8.4.4 High Signal Throughput

With a bandwidth of 1.1 MHz at a gain of 20 V/V and a slew rate of 8 V/ $\mu$ s, the INA241x is specifically designed for detecting and protecting applications from fast inrush currents. As shown in Table 8-1, the INA241x responds in less than 1  $\mu$ s for a system measuring a 75 A threshold on a 2 m $\Omega$  shunt.

Table 8-1. Response Time

	PARAMETER	EQUATION	INA241x AT V <sub>S</sub> = 5 V
G	Gain		20 V/V
I <sub>MAX</sub>	Maximum current		100 A
I <sub>Threshold</sub>	Threshold current		75 A
R <sub>SENSE</sub>	Current sense resistor value		2 mΩ
V <sub>OUT_MAX</sub>	Output voltage at maximum current	$V_{OUT\_MAX} = I_{MAX} \times R_{SENSE} \times G$	4 V
V <sub>OUT_THR</sub>	Output voltage at threshold current	V <sub>OUT_THR</sub> = I <sub>THR</sub> × R <sub>SENSE</sub> × G	3 V
SR	Slew rate		8 V/µs
T <sub>response</sub>	Output response time	T <sub>response</sub> = V <sub>OUT_THR</sub> / SR	< 1 µs



## 9 Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

The INA241x amplifies the voltage developed across a current-sensing resistor as current flows through the resistor to the load. The wide input common-mode voltage range and high common-mode rejection of the INA241x make it usable over a wide range of voltage rails while still maintaining an accurate current measurement.

### 9.1.1 R<sub>SENSE</sub> and Device Gain Selection

The accuracy of any current-sense amplifier is maximized by choosing the largest current-sense resistor value possible. A larger value sense resistor maximizes the differential input signal for a given amount of current flow and reduces the error contribution of the offset voltage. However, there are practical limits as to how large the current-sense resistor value can be in a given application because of the physical dimensions of the package, package construction, and maximum power dissipation. Equation 2 gives the maximum value for the current-sense resistor for a given power dissipation budget:

$$R_{SENSE} < \frac{PD_{MAX}}{I_{MAX}^2} \tag{2}$$

#### where:

- PD<sub>MAX</sub> is the maximum allowable power dissipation in R<sub>SENSE</sub>.
- I<sub>MAX</sub> is the maximum current that will flow through R<sub>SENSE</sub>.

An additional limitation on the size of the current-sense resistor and device gain is due to the power-supply voltage,  $V_S$ , and device swing-to-rail limitations. To make sure that the current-sense signal is properly passed to the output, both positive and negative output swing limitations must be examined. Equation 3 provides the maximum values of  $R_{SENSE}$  and GAIN to keep the device from exceeding the positive swing limitation.

$$I_{MAX} \times R_{SENSE} \times GAIN < V_{SP}$$
 (3)

#### where:

- I<sub>MAX</sub> is the maximum current that will flow through R<sub>SENSE</sub>.
- · GAIN is the gain of the current-sense amplifier.
- V<sub>SP</sub> is the positive output swing of the device as specified in the Specifications.

To avoid positive output swing limitations when selecting the value of R<sub>SENSE</sub>, there is always a trade-off between the value of the sense resistor and the gain of the device under consideration. If the sense resistor selected for the maximum power dissipation is too large, then it is possible to select a lower gain device to avoid positive swing limitations.

The negative swing limitation places a limit on how small the sense resistor value can be for a given application. Equation 4 provides the limit on the minimum value of the sense resistor.

$$I_{MIN} \times R_{SENSE} \times GAIN > V_{SN}$$
 (4)

#### where:

I<sub>MIN</sub> is the minimum current that will flow through R<sub>SENSE</sub>.

- GAIN is the gain of the current-sense amplifier.
- V<sub>SN</sub> is the negative output swing of the device as specified in the Specifications.

Table 9-1 shows an example of the different results obtained from using five different gain versions of the INA241x. From the table data, the highest gain device allows a smaller current-shunt resistor and decreased power dissipation in the element.

Table 9-1. R <sub>SENSE</sub> Selection and Power Dissipation	(1	)	
---	----	---	--

				5 V			
PARAMETER		EQUATION	A1, B1 DEVICES	A2, B2 DEVICES	A3, B3 DEVICES	A4, B4 DEVICES	A5, B5 DEVICES
G	Gain		10 V/V	20 V/V	50 V/V	100 V/V	200 V/V
V <sub>SENSE</sub>	Ideal differential input voltage	V <sub>SENSE</sub> = V <sub>OUT</sub> / G	500 mV	250 mV	100 mV	50 mV	25 mV
R <sub>SENSE</sub>	Current sense resistor value	R <sub>SENSE</sub> = V <sub>SENSE</sub> / I <sub>MAX</sub>	50 mΩ	25 mΩ	10 mΩ	5 mΩ	2.5 mΩ
P <sub>SENSE</sub>	Current-sense resistor power dissipation	R <sub>SENSE</sub> × I <sub>MAX</sub> 2	5 W	2.5 W	1 W	0.5 W	0.25 W

(1) Design example with 10 A full-scale current with maximum output voltage set to 5 V.

### 9.2 Typical Application

The INA241x is a bidirectional, current-sense amplifier capable of measuring currents through a resistive shunt with common-mode voltages from –5 V to +110 V.

### 9.2.1 Inline Motor Current-Sense Application

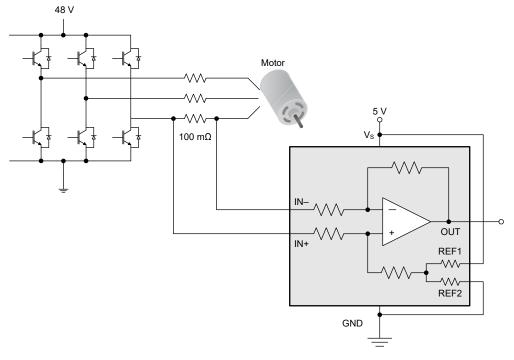


Figure 9-1. Inline Motor Application Circuit

#### 9.2.1.1 Design Requirements

Inline current sensing has many advantages in motor control, from torque ripple reduction to real-time motor health monitoring. However, the full-scale PWM voltage requirements for inline current measurements provide challenges to accurately measure the current. Switching frequencies in the 50 kHz to 100 kHz range create higher  $\Delta V/\Delta t$  signal transitions that must be addressed to obtain accurate inline current measurements.

With a superior common-mode rejection capability, high precision, and a high common-mode specification, the INA241x provides performance for a wide range of common-mode voltages.



### 9.2.1.2 Detailed Design Procedure

For this application, the INA241x measures current in the drive circuitry of a 48 V, 4000 RPM motor.

To demonstrate the performance of the device, the INA241A2 with a gain of 20 V/V was selected for this design and powered from a 5 V supply.

Using the information in the Section 8.4.3.2 section, the reference point is set to mid-scale by splitting the supply with REF1 connected to supply and REF2 connected to ground. This configuration allows for bipolar current measurements. Alternatively, the reference pins can be tied together and driven with an external precision reference.

The current-sensing resistor is sized so that the output of the INA241x is not saturated. A value of 100 m $\Omega$  was selected to maintain the analog input within the device limits.

### 9.2.1.3 Application Curve

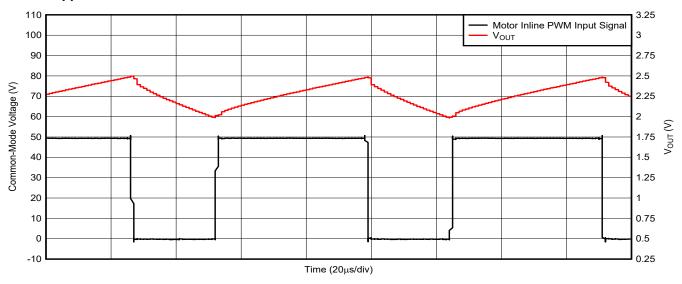


Figure 9-2. INA241A2 Inline Motor Current-Sense Input and Output Signals

## 9.3 Power Supply Recommendations

The INA241x makes accurate measurements beyond the connected power-supply voltage ( $V_S$ ) because the inputs (IN+ and IN-) can operate anywhere between -5 V and +110 V independent of  $V_S$ . For example, with the  $V_S$  power supply equal to 5 V, the common-mode voltage of the measured shunt can be as high as +110 V.

### 9.3.1 Power Supply Decoupling

Place the power-supply bypass capacitor as close to the supply and ground pins as possible. TI recommends a bypass capacitor value of 0.1  $\mu$ F. Additional decoupling capacitance can be added to compensate for noisy or high-impedance power supplies.

### 9.4 Layout

### 9.4.1 Layout Guidelines

Attention to good layout practices is always recommended.

- Connect the input pins to the sensing resistor using a Kelvin or 4-wire connection. This connection technique
  makes sure that only the current-sensing resistor impedance is detected between the input pins. Poor routing
  of the current-sensing resistor commonly results in additional resistance present between the input pins.
  Given the very low ohmic value of the current sense resistor, any additional high-current carrying impedance
  can cause significant measurement errors.
- Place the power-supply bypass capacitor as close to the device power supply and ground pins as possible.
   The recommended value of this bypass capacitor is 0.1 µF. Additional decoupling capacitance can be added to compensate for noisy or high-impedance power supplies.

### 9.4.2 Layout Examples

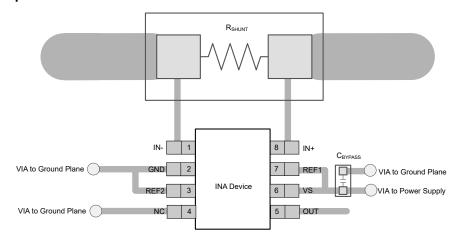


Figure 9-3. INA241x SOT-23 (DDF), SOIC (D) and VSSOP (DGK) Package Recommended Layout



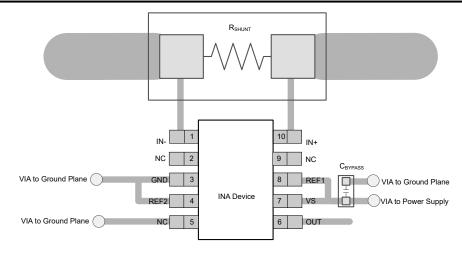


Figure 9-4. INA241x 10-Pin VSSOP (DGS) Package Recommended Layout



## 10 Device and Documentation Support

### 10.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### **10.2 Support Resources**

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 10.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

### 10.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 10.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Submit Document Feedback





26-Aug-2023 www.ti.com

## **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
INA241A1IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PH3	Samples
INA241A1IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2U6B	Samples
INA241A2IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PI3	Samples
INA241A2IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2U7B	Samples
INA241A3IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PJ3	Samples
INA241A3IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2U8B	Samples
INA241A4IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PK3	Samples
INA241A4IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2U9B	Samples
INA241A5IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PL3	Samples
INA241A5IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2UAB	Samples
INA241B1IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PM3	Samples
INA241B1IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2UBB	Samples
INA241B2IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PN3	Samples
INA241B2IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2UCB	Samples
INA241B3IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PO3	Samples
INA241B3IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2UDB	Samples
INA241B4IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PP3	Samples
INA241B4IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2UEB	Samples
INA241B5IDDFR	ACTIVE	SOT-23-THIN	DDF	8	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2PQ3	Samples
INA241B5IDGKR	ACTIVE	VSSOP	DGK	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2UFB	Samples

# **PACKAGE OPTION ADDENDUM**

www.ti.com 26-Aug-2023

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF INA241A, INA241B:

Automotive: INA241A-Q1, INA241B-Q1

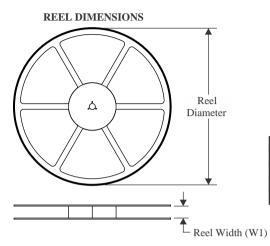
NOTE: Qualified Version Definitions:

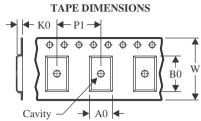
Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects



www.ti.com 27-Aug-2023

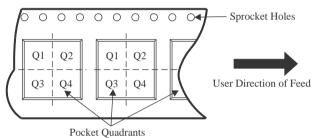
### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
INA241A1IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241A1IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA241A2IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241A2IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA241A3IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241A3IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA241A4IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241A4IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA241A5IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241A5IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA241B1IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241B1IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1



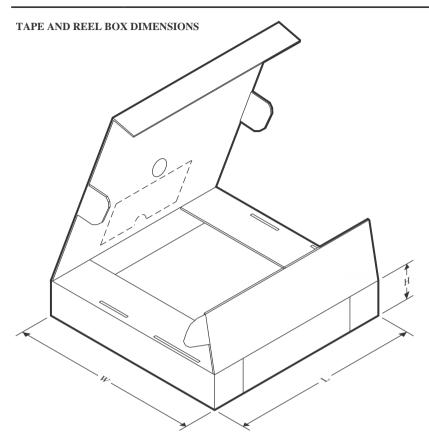
# PACKAGE MATERIALS INFORMATION

www.ti.com 27-Aug-2023

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
INA241B2IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241B2IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA241B3IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241B3IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA241B4IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241B4IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA241B5IDDFR	SOT-23- THIN	DDF	8	3000	180.0	8.4	3.15	3.1	1.55	4.0	8.0	Q3
INA241B5IDGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1



www.ti.com 27-Aug-2023



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
INA241A1IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241A1IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
INA241A2IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241A2IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
INA241A3IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241A3IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
INA241A4IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241A4IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
INA241A5IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241A5IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
INA241B1IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241B1IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
INA241B2IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241B2IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
INA241B3IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241B3IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0
INA241B4IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241B4IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0



# PACKAGE MATERIALS INFORMATION

www.ti.com 27-Aug-2023

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
INA241B5IDDFR	SOT-23-THIN	DDF	8	3000	210.0	185.0	35.0
INA241B5IDGKR	VSSOP	DGK	8	2500	356.0	356.0	35.0

# DGK (S-PDSO-G8)

# PLASTIC SMALL-OUTLINE PACKAGE



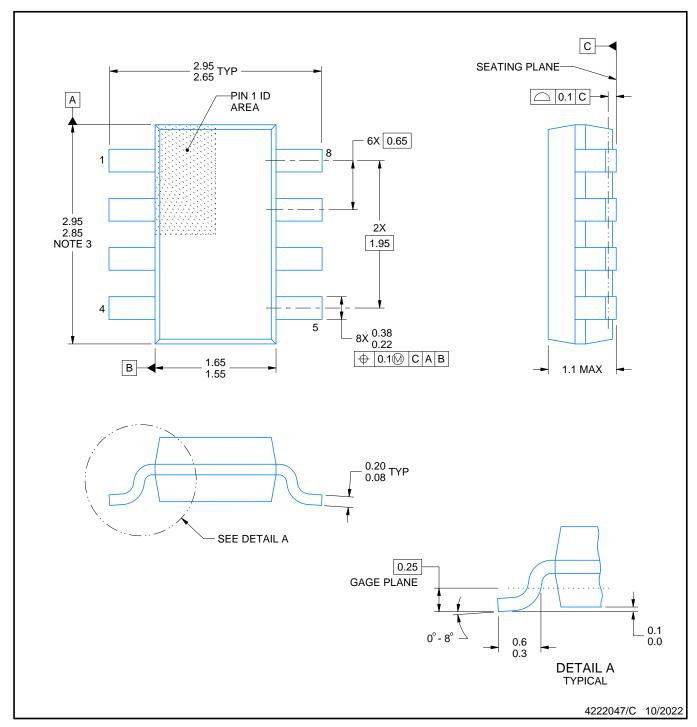
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.





PLASTIC SMALL OUTLINE



### NOTES:

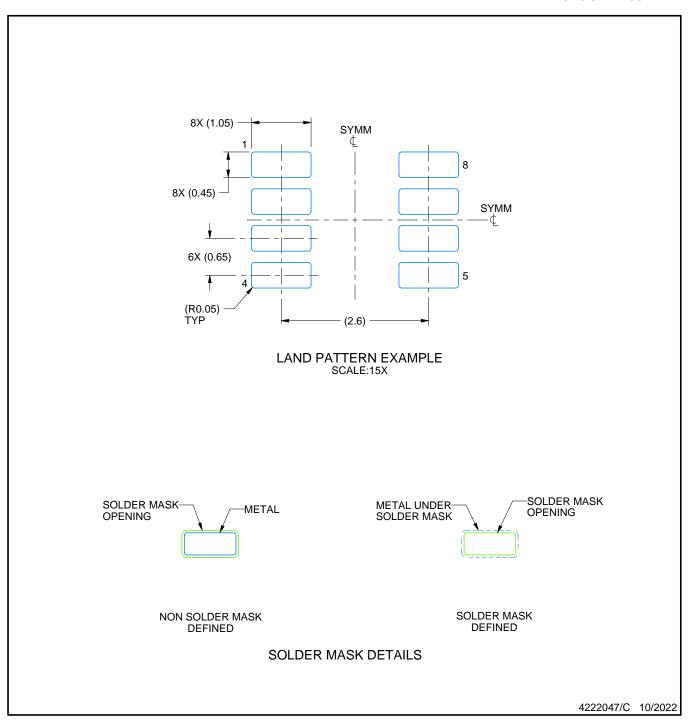
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.



PLASTIC SMALL OUTLINE

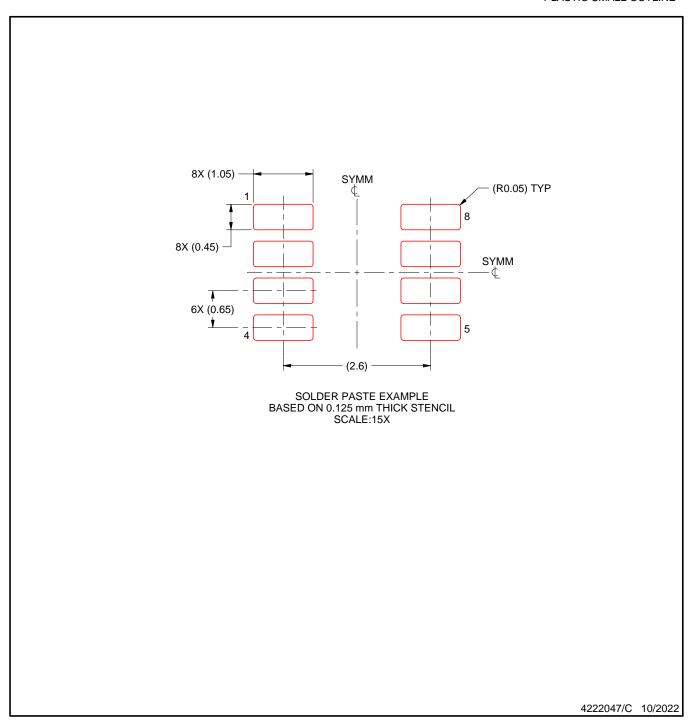


NOTES: (continued)

- 4. Publication IPC-7351 may have alternate designs.
- 5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



PLASTIC SMALL OUTLINE



NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 7. Board assembly site may have different recommendations for stencil design.



### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2023, Texas Instruments Incorporated

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Current Sense Amplifiers category:

Click to view products by Texas Instruments manufacturer:

Other Similar products are found below:

COSINA180A3 LMP8278QMMX/NOPB LT6107HS5#TRPBF INA241A2IDDFR INA241A3IDDFR INA241A2QDDFRQ1
INA241A5IDDFR INA241B2QDDFRQ1 INA281A3IDBVR INA296A3IDDFR INA241A1IDDFR WS74285C-8/TR INA296A2QDDFRQ1
INA296A5IDDFR INA241B2IDDFR INA211CIRSWR INA296A1QDDFRQ1 INA296A3QDDFRQ1 INA212BIDCKR MAX9937AXK+T
MAX4080FAUA+T MAX4073FAXK+T NTE955M INA240A3PWR INA199C3DCKT LTC6102CMS8#TRPBF LT6106CS5#TRPBF
INA214CIDCKR INA199C2DCKT AD8211WYRJZ-R7 INA199C1DCKT MAX9610HEXK+T INA199C1DCKR LMP8480ATQDGKRQ1
INA212BIRSWR INA199C1QDCKRQ1 INA199C2DCKR INA211BIRSWR INA210CIDCKT INA214BQDCKRQ1 INA199C3RSWR
INA213CQDCKRQ1 INA212CIDCKR LMP8480ASQDGKRQ1 INA212CIRSWT LMP8481AHQDGKRQ1 INA231AIYFDR
INA211CIRSWT INA213CIDCKR INA214CIRSWR